

# Total ionizing dose effects on aluminum oxide/zirconium-doped hafnium oxide stack ferroelectric tunneling junctions

Xueqin YANG<sup>1,2</sup>, Yannan XU<sup>1,2</sup>, Jinshun BI<sup>1,2\*</sup>, Kai XI<sup>1</sup>, Linjie FAN<sup>1,2</sup>,  
Lanlong JI<sup>1</sup> & Gaobo XU<sup>1</sup>

<sup>1</sup>Institute of Microelectronics, Chinese Academy of Sciences, Beijing 100029, China;

<sup>2</sup>University of Chinese Academy of Sciences, Beijing 100049, China

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Dear editor,

Ferroelectric random access memory (FeRAM) technologies based on hafnium oxide (HfO<sub>2</sub>) are promising candidates for future non-volatile memory applications due to their scalability and complementary metal-oxide semiconductor (CMOS) compatibility [1]. Among them, HfO<sub>2</sub>-based ferroelectric tunneling junction (FTJ) has been attracting greater attention for many emerging applications than Fe-cap and FeFET due to its non-destructive readout, simple structure, high density, low power consumption, and high operation speed [2]. Moreover, because of the reported rad-hard performance of HfO<sub>2</sub>-based FeRAM in a radiation environment [3], HfO<sub>2</sub>-based FTJ is expected to have a high potential for harsh environments, such as those in the military and aerospace. However, there is little research addressing the radiation effects on HfO<sub>2</sub>-based FTJ. Understanding the influence of radiation on the HfO<sub>2</sub>-based FTJs is essential before they can be applied in the field of aerospace. Up till now, the balance between the polarization value and the tunneling current strongly depending on the ferroelectric film thickness reduction has been a critical issue for HfO<sub>2</sub>-based FTJs [4]. Recently, a new type of ferroelectric tunneling junctions based on HfO<sub>2</sub>/dielectric bilayer structure has been reported, which can meet the above requirements [5]. The insert layer Al<sub>2</sub>O<sub>3</sub> can increase the tunneling current even when the ferroelectric film is thicker than 10 nm.

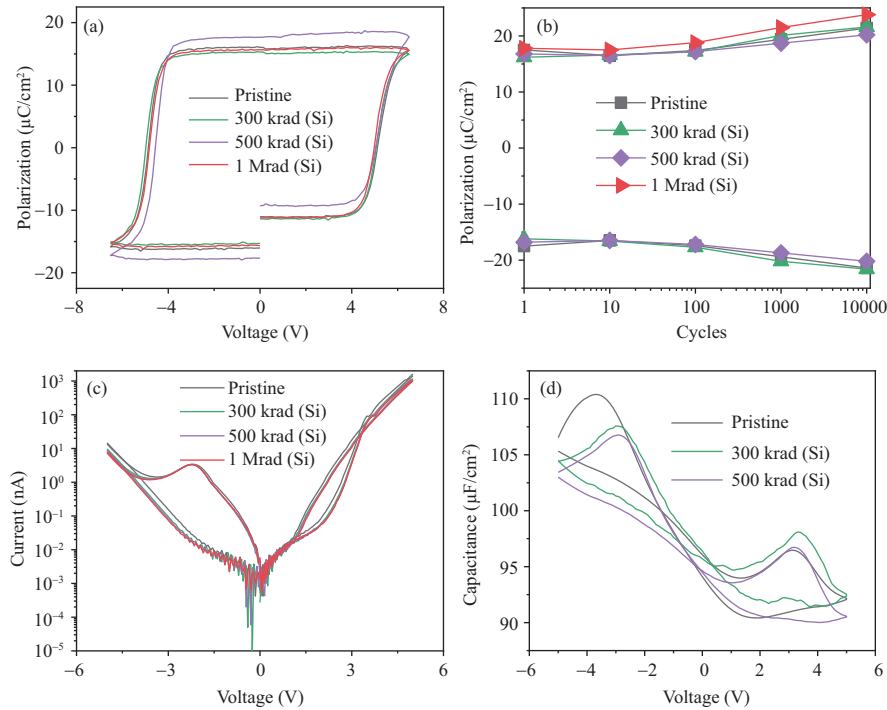
Hence, this study investigates the radiation effects on a TiN/Zr-doped-HfO<sub>2</sub> (HZO)/Al<sub>2</sub>O<sub>3</sub>/P<sup>+</sup>-Ge FTJ structure. The electrical performances, such as hysteresis loop, capacitance, leakage current,  $R_{\text{OFF/ON}}$ , and endurance characteristics are studied before and after radiation. The ferroelectric properties, such as hysteresis loop and endurance are found to be extremely resistant to the total ionizing dose (TID) radiation. However, the read currents, which are related to Al<sub>2</sub>O<sub>3</sub> change severely. The underlying physical mechanism is also investigated.

**Results and discussion.** The process of device fabrication, the corresponding physical property analysis and experiment parameter settings are described in Appendix A specifically. The  $P$ - $V$  characteristics of the device are shown in Figure 1(a). It can be seen that there is no obvious change in the  $P$ - $V$  hysteresis loops after radiation, and the remanent polarization is about 15.5  $\mu\text{C}/\text{cm}^2$ . This indicates high radiation tolerance of HfO<sub>2</sub> ferroelectricity, which is consistent with previous publication [3]. Meanwhile, the endurance performance and  $I$ - $V$  curves have negligible changes after radiation as shown in Figures 1(b) and (c), which also suggest that ferroelectric material HZO is robust to radiation. However, the  $C$ - $V$  characteristics demonstrate some obvious changes, as shown in Figure 1(d). The capacitance decreases at a negative voltage and increases slightly at a positive voltage and the shapes of the  $C$ - $V$  curves have some contractions with the increase of TID. The phenomenon is caused mainly by the radiation-induced positive fixed charge in the dielectric Al<sub>2</sub>O<sub>3</sub> [6, 7]. A large number of electron and hole pairs were generated during the TID radiation, and the dielectric Al<sub>2</sub>O<sub>3</sub> captured more holes to form net positive fixed charges as well as interface charges near the Ge side [8]. The positive fixed charge broadens the width of the depletion region of P<sup>+</sup>-Ge and weakens the band bending in the accumulation region of P<sup>+</sup>-Ge with the increase of TID.

Different from the traditional HfO<sub>2</sub>-based Fe-cap, the tunneling current and  $R_{\text{OFF/ON}}$  characteristics are also very critical for FTJ. The radiation effects on the tunneling current and  $R_{\text{OFF/ON}}$  characteristics are discussed in Appendix A in detail.

**Conclusion.** In this study, the TID effects on the FTJs with HfO<sub>2</sub>/Al<sub>2</sub>O<sub>3</sub> dielectric bilayer are investigated. The  $P$ - $V$ ,  $C$ - $V$ ,  $I$ - $V$ , endurance, and read current characteristics are analyzed before and after radiation. The  $I$ - $V$ ,  $P$ - $V$  and endurance characteristics show very little change after the total dose of up to 1 Mrad (Si), which means the ferro-

\* Corresponding author (email: [bijinshun@ime.ac.cn](mailto:bijinshun@ime.ac.cn))



**Figure 1** (Color online) (a)  $P$ - $V$  hysteresis loop of FTJs, (b) endurance performance, (c)  $I$ - $V$  curves, and (d)  $C$ - $V$  curves with increasing total dose.

electricity is not affected by the TID. However, owing to the positive fixed charges formed in  $\text{Al}_2\text{O}_3$  film and the interface traps accumulation during the radiation, the read current of the programed device is increasing, while the read current of the erased device is reducing after radiation. These findings are useful in understanding the radiation mechanisms of  $\text{HfO}_2$ /dielectric bilayer-based FTJs and can promote the application of FTJs in the nuclear and aerospace environments.

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**Supporting information** Appendix A. The supporting information is available online at [info.scichina.com](http://info.scichina.com) and [link.springer.com](http://link.springer.com). The supporting materials are published as submitted, without typesetting or editing. The responsibility for scientific accuracy and content remains entirely with the authors.

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